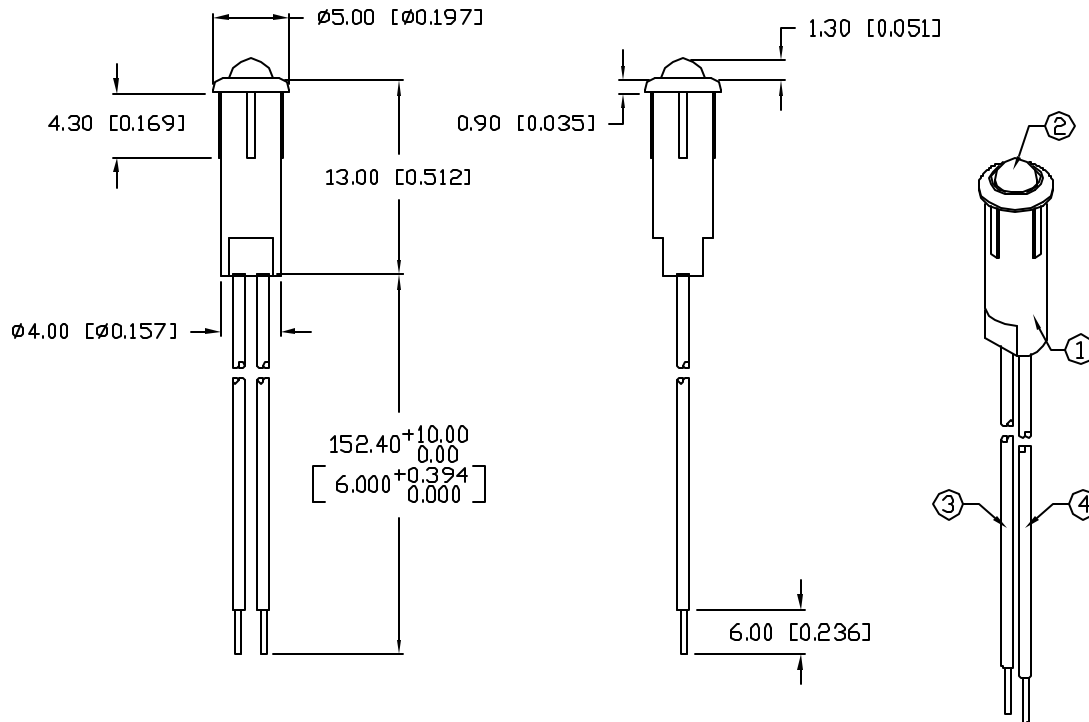


UNCONTROLLED DOCUMENT

PART NUMBER
SSI-LXH312YD-150

REV.
B

REV.	E.C.N. NUMBER AND REVISION COMMENTS	DATE
A	ADDED NOTE #3.	5.12.95
B	E.C.N. #10BRDR. & REDRAWN.	7.12.01



NOTES:

- SSH-LXH3121 HOLDER, BLACK NYLON 94-V.
- SSL-LX3044YD LED, LEADS CUT TO 5mm.
- ANODE LEAD: LXP-WST26RDT0C, RED INSULATED LEAD, 26 AWG, CUT 158mm LONG, STRIP 3.0mm & 6.0mm.
- CATHODE LEAD: LXP-WST26BLT0C, BLACK INSULATED LEAD, 26 AWG, CUT 158mm LONG, STRIP 3.0mm & 6.0mm.
- MOUNTING HOLE: $\phi 0.170'' - \phi 0.174''$

ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		585		nm	
FORWARD VOLTAGE		2.1	2.6	V_f	
REVERSE VOLTAGE	5.0			V_r	$I_f=100\mu\text{A}$
AXIAL INTENSITY		30		med	$I_f=20\text{mA}$
VIEWING ANGLE		60		2x theta	
EMITTED COLOR:	YELLOW				
EPOXY LENS FINISH:	YELLOW DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.2	mW/°C
OPERATING, STORAGE TEMP.	-40 TO +85	°C
SOLDERING TEMP.	+260	°C
2.0mm FROM BODY		3 SEC. MAX

* $t < 10\mu\text{s}$

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030), MIN= ^{+DECIMAL PRECISION} -0.00 ^{MAX.= +0.00} -DECIMAL PRECISION

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REV.	PART NUMBER
B	SSI-LXH312YD-150

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290 E. HELEN ROAD
PALATINE, IL 60067-6976
PHONE: +1.847.359.2790
US WEB: www.lumex.com
TW WEB: www.lumex.com.tw

T-3mm LED BLACK PANEL INDICATOR WITH 6" WIRE LEADS,
585nm YELLOW LED, YELLOW DIFFUSED LENS.

RELIABILITY NOTE
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY:	CHECKED BY:	APPROVED BY:	DATE:
GT			1.6.93
			PAGE: 1 OF 1
			SCALE: N/A